



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-------------------------------------------------|
| Chip Size | 0805 |
| L | 2.01mm +0.81/-0.25mm (0.079 in +0.032/-0.01 in) |
| W | 1.27mm +0.68/-0.25mm (0.05 in +0.027/-0.01 in) |
| T | 1.57mm MAX (0.062 in MAX) |
| B | 0.51mm +/-0.25mm (0.02 in +/-0.01 in) |

Packaging Specifications

| | |
|--------------------|------|
| Packaging | T&R |
| Packaging Quantity | 4000 |

General Information

| | |
|----------------|------------------------------------------------------------------------------------------------------------------------------|
| Series | SMD MIL COG PRF32535 |
| Style | SMD Chip |
| Description | SMD, Low ESR, MIL-PRF-32535 |
| RoHS | No |
| Prop 65 | ⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov . |
| Termination | Solder Dipped |
| Failure Rate | N/A |
| Qualifications | MIL-PRF-32535 T-Level |
| AEC-Q200 | No |
| Shelf Life | 78 Weeks |
| MSL | 1 |

Specifications

| | |
|---------------------------------|---------------------|
| Capacitance | 1000 pF |
| Capacitance Tolerance | 10% |
| Voltage DC | 50 VDC |
| Dielectric Withstanding Voltage | 125 VDC |
| Temperature Range | -55/+125°C |
| Temperature Coefficient | COG |
| Dissipation Factor | 0.15% 1 MHz 25C |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 100 GOhms |

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)